onsemi

MOSFET – N-Channel QFET

1000 V, 8 A, 1.45 Ω

FQD30N06

Description

This N-Channel Enhancement Mode Power MOSFET is produced using **onsemi**'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 22.7 A, 60 V $R_{DS(on)}$ = 45 m Ω (Max.) @ V_{GS} = 10 V, I_D = 11.4 A
- Low Gate Charge (Typ. 19 nC)
- Low Crss (Typ. 40 pF)
- 100% Avalanche Tested
- This Device is Pb-Free Halide, Free and RoHS Compliant

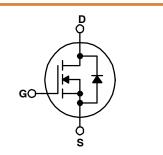
MOSFET MAXIMUM RATINGS (T_C = 25°C unless otherwise noted.)

| Symbol | Parameter | Value | Unit |
|----------------------------------|--|--------------|-----------|
| V _{DSS} | Drain to Source Voltage | 60 | V |
| I _D | Drain Current – Continuous (T _C = 25°C) – Continuous (T _C = 100°C) | 22.7 14.3 | A |
| I _{DM} | Drain Current – Pulsed (Note 1) | 90.8 | А |
| V _{GSS} | Gate-Source Voltage | ±25 | V |
| E _{AS} | Single Pulse Avalanche Energy (Note 2) | 280 | mJ |
| I _{AR} | Avalanche Current (Note 1) | 22.7 | А |
| E _{AR} | Repetitive Avalanche Energy (Note 1) | 4.4 | mJ |
| dv/dt | Peak Diode Recovery dv/dt (Note 3) | 7.0 | V/ns |
| P _D | Power Dissipation (T _A = 25° C) * | 2.5 | W |
| | Power Dissipation - (T _C = 25°C) - Derate Above 25°C | 44 0.35 | W W/°C |
| T _J ,T _{STG} | Operating and Storage Temperature Range | -55 to +150 | °C |
| TL | Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds | 300 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



TO-252-3 CASE 369AS



MARKING DIAGRAM

| | &Z&3&K FQD 30N06 | |
|----------------------------|---------------------------|--|
| &Z &3 &K FQD30N06 | = Numeric = 2–Digit Lo | |

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------|-----------------------|-----------------------|
| FQD30N06 | TO-252-3 (Pb-Free) | 2500 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

THERMAL CHARACTERISTICS

| Symbol | Parameter | Value | Unit | |
|-----------------|--|-------|------|--|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 2.85 | | |
| $R_{	hetaJA}$ | Thermal Resistance, Junction to Ambient (Minimum Pad of 2–oz Copper), Max. | 110 | °C/W | |
| | Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2–oz Copper), Max. | 50 | | |

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit |
|--|---|---|-----|-------|-------|------|
| Off Chara | cteristics | - | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | V_{GS} = 0 V, I _D = 250 µA | 60 | - | - | V |
| $\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250 \ \mu$ A, Referenced to 25° C | - | 0.06 | _ | V/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 60 V, V _{GS} = 0 V | - | - | 1 | μA |
| | Zero Gate Voltage Drain Current | V_{DS} = 48 V, T_{C} = 125°C | - | - | 10 | μA |
| I _{GSSF} | Gate to Body Leakage Current, Forward | $V_{GS} = 25 \text{ V}, V_{DS} = 0 \text{ V}$ | - | - | 100 | nA |
| I _{GSSR} | Gate to Body Leakage Current, Reverse | $V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$ | - | - | -100 | nA |
| On Chara | cteristics | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 2.0 | - | 4.0 | V |
| R _{DS(on)} | Static Drain-Source On-Resistance | V _{GS} = 10 V, I _D = 11.4 A | - | 0.036 | 0.045 | Ω |
| 9 _{FS} | Forward Transconductance | V _{DS} = 25 V, I _D = 11.4 A | - | 15 | _ | S |
| Dynamic (| Characteristics | | | | | |
| C _{iss} | Input Capacitance | V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz | - | 725 | 945 | pF |
| Coss | Output Capacitance | - | - | 270 | 350 | pF |
| C _{rss} | Reverse Transfer Capacitance | | - | 40 | 52 | pF |
| Switching | Characteristics | - | | | | |
| t _{d(on)} | Turn-On Delay Time | $V_{DD} = 30 \text{ V}, \text{ I}_{D} = 15 \text{ A},$ | - | 10 | 30 | ns |
| t _r | Turn-On Rise Time | R _G = 25 Ω (Note 4) | - | 85 | 180 | ns |
| t _{d(off)} | Turn-Off Delay Time | - | - | 35 | 80 | ns |
| t _f | Turn-Off Fall Time | | - | 40 | 90 | ns |
| Qg | Total Gate Charge | V _{DS} = 48 V, I _D = 30 A, V _{GS} = 10 V (Note 4) | - | 19 | 25 | nC |
| Qgs | Gate-Source Charge | | - | 5.4 | - | nC |
| Qgd | Gate-Drain Charge | | _ | 8.5 | _ | nC |
| Drain-So | urce Diode Characteristics and Maximum | Ratings | | | | |
| I _S | Maximum Continuous Drain-Source Diode Forward Current | | - | - | 22.7 | А |
| I _{SM} | Maximum Pulsed Drain-Source Diode For | ximum Pulsed Drain-Source Diode Forward Current | | - | 90.8 | А |
| 14 | | | | | 4.5 | |

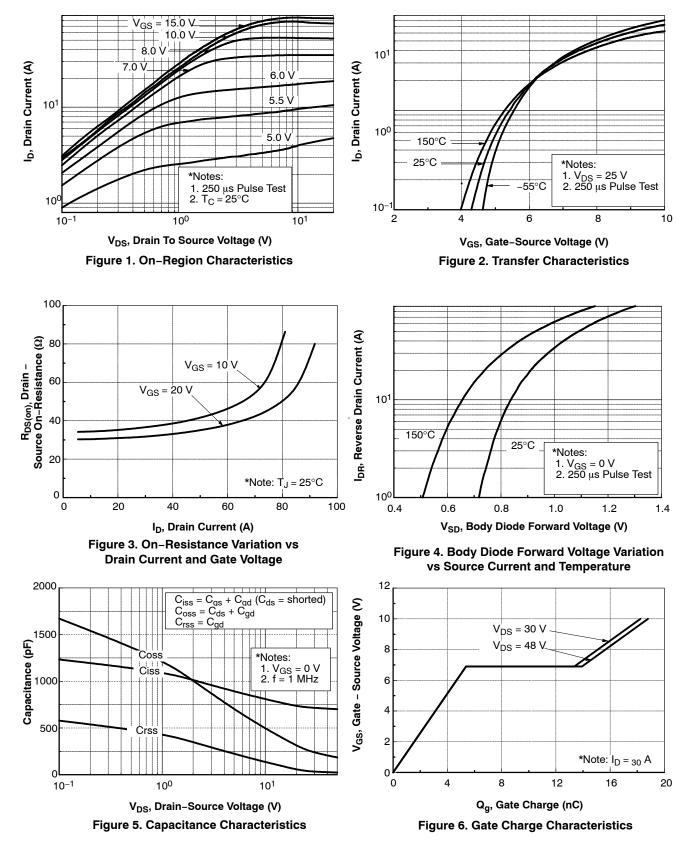
| V | SD | Drain-Source Diode Forward Voltage | $V_{GS} = 0 \text{ V}, \text{ I}_{S} = 22.7 \text{ A}$ | - | - | 1.5 | V |
|--|-----------------|------------------------------------|--|---|----|-----|----|
| t | t _{rr} | Reverse Recovery Time | $V_{GS} = 0 V, I_{S} = 30 A,$ | - | 45 | - | ns |
| C | ۵ _{rr} | Reverse Recovery Charge | dI _F /dt = 100 A/µs | - | 65 | - | nC |
| Durch at a superstation of superstation is indicated in the Electrical Observatoristics for the listed test conditions, unless otherwise poted. Durch at | | | | | | | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

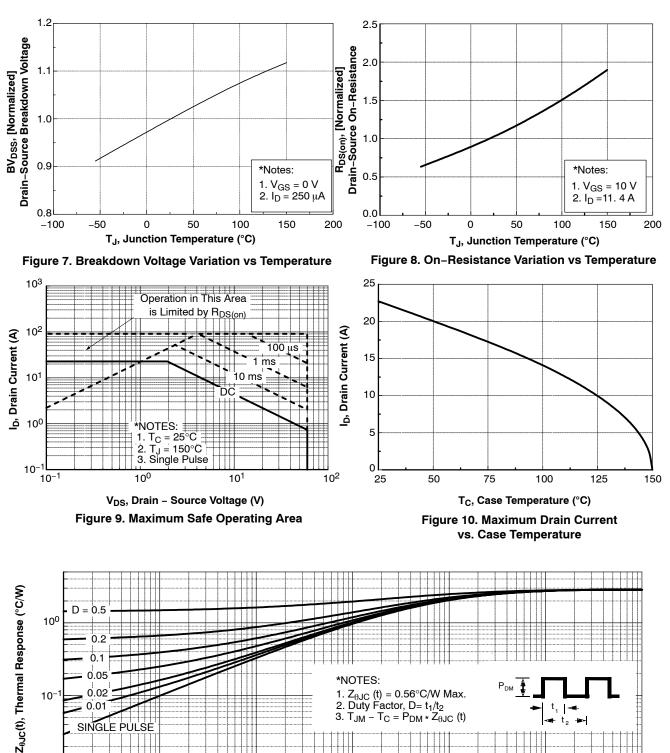
NOTES:

1. Repetitive Rating: Pulse-width limited by maximum junction temperature. 2. L = 630 μ H, I_{AS} = 227 A, V_{DD} = 25 V, R_G = 25 Ω starting T_J = 25°C. 3. I_{SD} ≤ 30 A, di/dt ≤ 300 A/ μ s, V_{DD} ≤ BV_{DSS}, starting T_J = 25°C. 4. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (CONTINUED)





*NOTES:

10⁻²

З.

t₁, Rectangular Pulse Duration (s) Figure 11. Transient Thermal Response Curve

10⁻³

1. $Z_{\theta JC}$ (t) = 0.56°C/W Max. 2. Duty Factor, D= t_1/t_2 (i)

 $T_{JM} - T_C = P_{DM} \star Z_{\theta JC}$ (t)

10⁻¹

P_{DM}

t 1

10⁰

10¹

05

.02

SINGLE PULSE

10⁻⁴

0.01

10

10

10⁻⁵

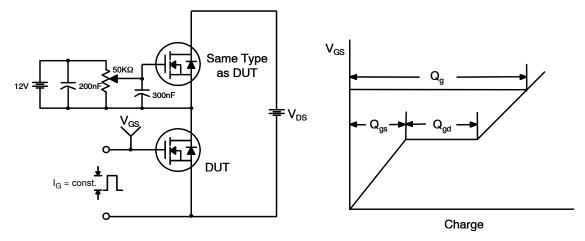


Figure 12. Gate Charge Test Circuit & Waveform

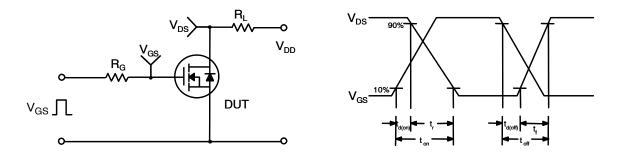


Figure 13. Resistive Switching Test Circuit & Waveforms

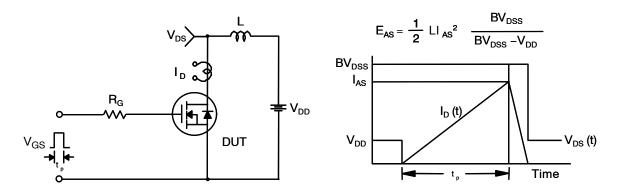
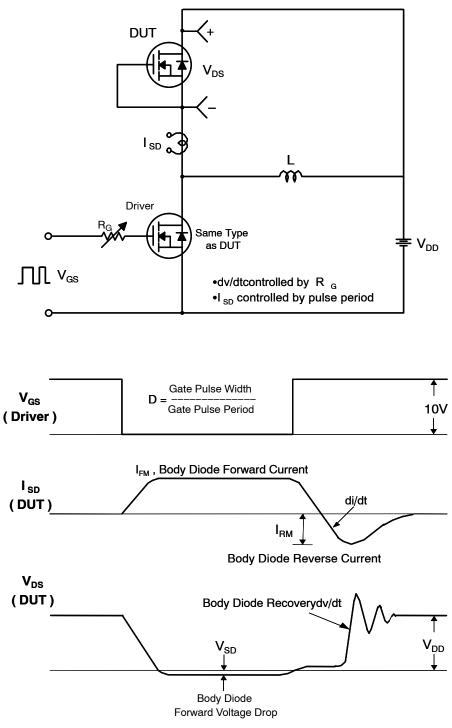
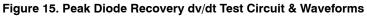
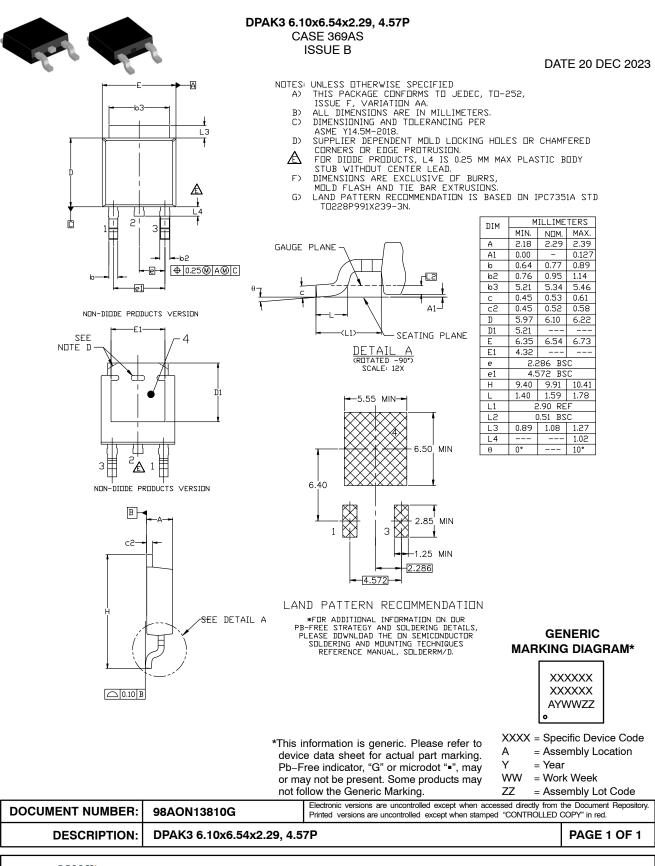


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





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